

Scope

This specification covers the 0.5 mm Pitch FPC Connector THD0510 series.

Ordering information

Т	<u> HD0510 - xx CL - GF</u>		
	0 0 0 4		
0	Series name: THD0510		
0	Number of contacts: 4 TO 60	•	Plating: GF= 1µ"~3µ" Gold Flash
8	Contact type:CL:Lower contact CU:Upper contact		G3= 3µ" Gold over Nickel G5= 5µ" Gold over Nickel SN= Tin(Lead Free) over Nickel

Rating

Item	Standard
Voltage Rating(Max.)	50V AC
Current Rating(Max.)	0.5A DC
Operating Temperature Range	-55°C ~ +85°C (Including terminal temperature rise)

Material

Housing	Actuator	Terminal	Solder pin	Plating
L.C.P (UL94V-0)	L.C.P (UL94V-0)			1µ″~3µ″
Color:White	Color: Black	Copper alloy	copper alloy	Gold over Nickel

Performance

ltem	Item Test Condition		Specification	
Contact Resistance	Mate applicable FPC and measure by dry circuit, 20mV Max, 1mA.	100 mΩ Max.		
Insulation Resistance	Mate applicable FPC and apply 500V DC between adjacent terminal or ground.	50 MΩ Min.		
Dielectric Strength	Mate applicable FPC, apply 250V AC(rms) for 1 minute between adjacent terminal or ground.	No Breakdown		
FPC Retention Force	Insert the actuator, pull the FPC at a rate of 25 ± 3 mm per minute.	Per pin x0.03Kgf (0.3N) Min.		
Terminal Retention Force	Apply axial pull out force at the rate of 25±3 mm/minute on the terminal assembled in the housing.	isial pull out force at the rate of 25±3 mm/minute terminal assembled in the housing.		
	Mate connectors and subject to the following vibration	Appearance	No Damage	
Vibration	perpendicular axes, passing DC 1mA during the test.	Contact Resistance	100 mΩ Max.	
	Frequency : 10~55~10 Hz in 1 minute. Duration : 2 hours in each of X,Y,Z axes.	Discontinuity	l µsec Max.	
	Mate applicable FPC and subject to the following shock	Appearance	No Damage	
Shock	6 directions along 3 mutually perpendicular axes, passing DC 1 mA current during the test.	Contact Resistance	100 mΩ Max.	
	Peak value : 490m/s ² {50G}	Discontinuity	l µsec Max.	
Salt Sprav	Mate applicable FPC and expose to the following salt mist conditions. Upon completion of the exposure period, salt deposits shall be removed by a gentle wash or dip in running water, after which the specified measurements shall be performed.	Appearance	No Damage	
	NaCl solution Concentration : 5 ± 1% Spray time :48 ± 4 hours Ambient temperature : 35 ± 2°C	Contact Resistance	100 mΩ Max.	

Item	Item Test Condition		Specification	
	Mate applicable FPC and expose to $85\pm2^{\circ}C$ for 96 hours. Upon completion of the exposure period, the test	Appearance	No Damage	
Heat Resistance	specimens shall be conditioned at ambient room conditions for 1 to 2 hours, after which the specified measurements shall be performed.	Contact Resistance	100 mΩ Max.	
	Mate applicable FPC and expose to $-40\pm2^{\circ}$ C for 96 hours. Upon completion of the exposure period, the test	Appearance	No Damage	
Cold Resistance	specimens shall be conditioned at ambient room conditions for 1 to 2 hours, after which the specified measurements shall be performed.	Contact Resistance	100 mΩ Max.	
	Mate applicable FPC and expose to 60 ± 2°C, relative humidity 90 to 95% for 96 hours. Upon completion of the exposure period, the test specimens shall be conditioned at ambient room conditions for 1 to 2 hours, after which the specified measurements shall be performed.	Appearance	No Damage	
		Contact Resistance	100 mΩ Max.	
Humidity		Dielectric Strength	No Breakdown	
		Insulation Resistance	50 MΩ Min.	
Temperature Rise	Mate applicable FPC and measure the temperature rise of contact when the maximum AC rated current is passed.	Temperature rise	30°C Max.	
	Mate applicable FPC and subject to the following conditions for 5 cycles. Upon completion of the exposure period, the test	Appearance	No Damage	
Temperature Cycling	<pre>specimens shall be conditioned at ambient room conditions for 1 to 2 hours, after which the specified measurements shall be performed. 1 cycle a) -55±3°C 30minutes b) +85±3°C 30minutes (Transit time shall be with in 3 minutes)</pre>	Contact Resistance	100 mΩ Max.	
Solderability	Tip of solder tails and fitting nails into the molten solder (held at 245 ± 5 °C) up to 0.1mm from the bottom of the housing for 3 ± 0.5 seconds.	Solder Wetting	95% of immersed area must show no voids, pin holes.	
Resistance to Soldering	When reflowing refer to Infrared reflow condition <u>Soldering iron method</u> 0.2mm from terminal tip and fitting nail tip. Soldering time : 5 seconds Max. Solder temperature : 370~400°C	Appearance	No Damage	

Recommended Temperature Profile





